

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load. For capacitance load, derate current by 20%.			
Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	200	V
RMS Reverse Voltage	V _{R(RMS)}	141	V
Average Rectified Output Current (See also figure 5)	lo	4	А
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave Superimposed on Rated Load	I _{FSM}	100	А

Thermal Characteristics

Characteristic	Symbol	Тур	Max	Unit
	Oymbol	тур		
Thermal Resistance Junction to Soldering Point	R ₀ JS	—	3.0	°C/W
Thermal Resistance Junction to Ambient Air (Note 5)	R _{0JA}	80	_	°C/W
Thermal Resistance Junction to Ambient Air (Note 6)	R _{0JA}	65	_	°C/W
Thermal Resistance Junction to Ambient Air (Note 7)	$R_{ heta JA}$	45		°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +175		°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 8)	V _{(BR)R}	200	_		V	I _R = 5μA
Forward Voltage	VF		0.76 0.785 0.61 0.84 0.68	0.82 0.59 0.84 0.64 0.89 0.75	V	$I_{F} = 3A, T_{S} = +25^{\circ}C$ $I_{F} = 3A, T_{S} = +150^{\circ}C$ $I_{F} = 4A, T_{S} = +25^{\circ}C$ $I_{F} = 4A, T_{S} = +150^{\circ}C$ $I_{F} = 8A, T_{S} = +25^{\circ}C$ $I_{F} = 8A, T_{S} = +150^{\circ}C$
Reverse Leakage Current (Note 8)	I _R		0.2 0.8	1 4	μA mA	$T_{S} = +25^{\circ}C, V_{R} = 200V$ $T_{S} = +150^{\circ}C, V_{R} = 200V$
Reverse Recovery Time	t _{rr}		_	25	ns	$I_F = 0.5A, I_R = 1.0A$ $I_{RR} = 0.25A$ (see Figure 8)

Notes: 5. FR-4 PCB, 2 oz. Copper, minimum recommended pad layout per http://www.diodes.com.

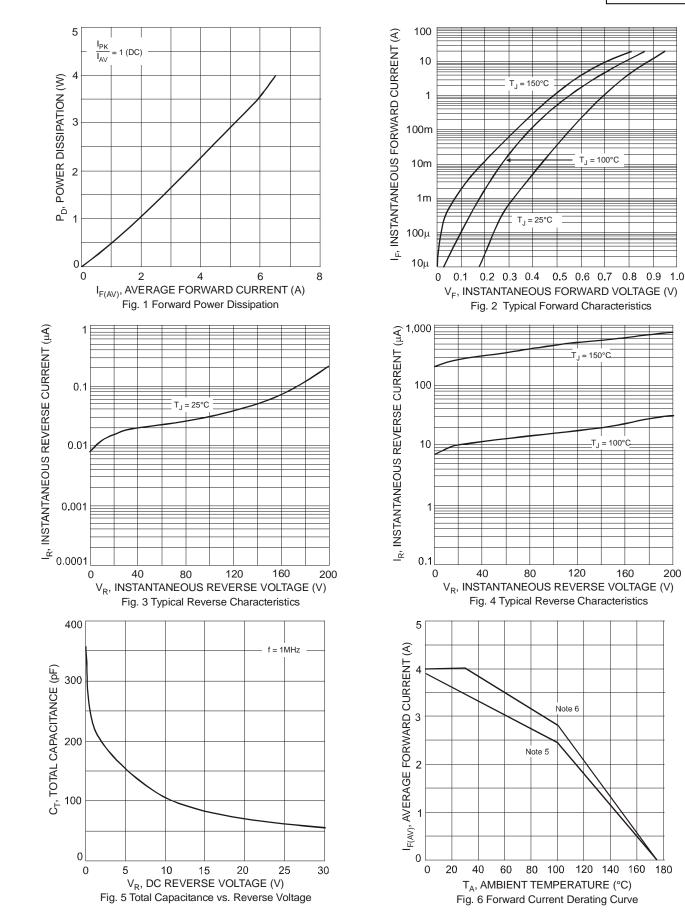
Polymide PCB, 2 oz. Copper, minimum recommended pad layout per http://www.diodes.com.
 Polymide PCB, 2 oz. Copper. Cathode pad dimensions 9.4mm x 7.2mm. Anode pad dimensions 2.7mm x 1.6mm.
 Short duration test pulse used to minimize self-heating effect.



 $T_{.1} = 100^{\circ}C$

160

200



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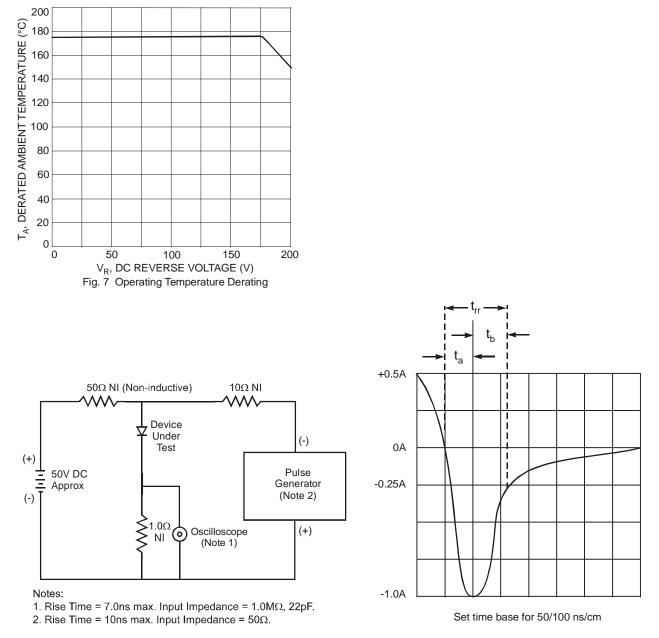
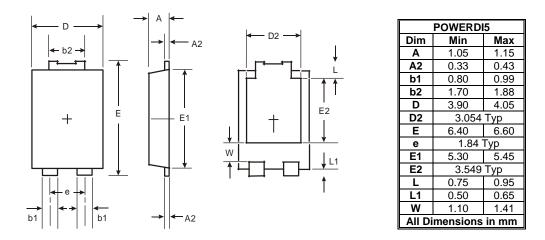


Fig. 8 Reverse Recovery Time Characteristic and Test Circuit



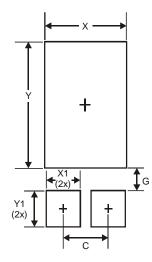
Package Outline Dimensions

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)	
С	1.840	
G	0.852	
Х	3.360	
X1	1.390	
Y	4.860	
Y1	1.400	



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